

Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	60			V	V _{GS} = 0V, I _D = 250µA
$\Delta V_{(BR)DSS} / \Delta T_J$	Breakdown Voltage Temp. Coefficient		0.07		V/°C	Reference to 25°C, I_D = 5mA $@$
R _{DS(on)}	Static Drain-to-Source On-Resistance		5.4	6.8		V _{GS} = 10V, I _D = 50A
			6.6	8.3		V _{GS} = 4.5V, I _D = 50A ⑤
V _{GS(th)}	Gate Threshold Voltage	1.0		2.5	V	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$
gfs	Forward Trans conductance	31			S	V _{DS} = 25V, I _D = 50A
R _{G(Int)}	Internal Gate Resistance		0.6		Ω	
I _{DSS}	Drain-to-Source Leakage Current			20	μA	V _{DS} = 60V, V _{GS} = 0V V _{DS} = 60V,V _{GS} = 0V,T _J =125°C
				250		V _{DS} = 60V,V _{GS} = 0V,T _J =125°C
I _{GSS}	Gate-to-Source Forward Leakage Gate-to-Source Reverse Leakage			100		V _{GS} = 16V
				-100		V _{GS} = -16V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

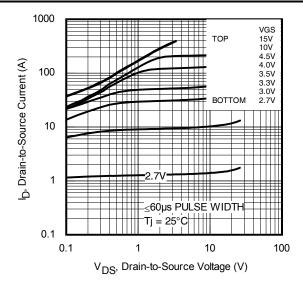
Q _g	Total Gate Charge		33	49		I _D = 50A
Q _{gs}	Gate-to-Source Charge		11		nC	V _{DS} = 30V
Q _{gd}	Gate-to-Drain Charge		15			V _{GS} = 4.5V⑤
Q _{sync}	Total Gate Charge Sync. (Q _g - Q _{gd})		18			
t _{d(on)}	Turn-On Delay Time		45			V _{DD} = 39V
t _r	Rise Time		216			I _D = 50A
t _{d(off)}	Turn-Off Delay Time		43		ns	R _G = 7.5Ω
t _f	Fall Time		69			V _{GS} = 4.5V⑤
C _{iss}	Input Capacitance		3779			V _{GS} = 0V
C _{oss}	Output Capacitance		332			V _{DS} = 50V
C _{rss}	Reverse Transfer Capacitance		163		pF	f = 1.0MHz
C _{oss eff.} (ER)	Effective Output Capacitance (Energy Related)		437			$V_{GS} = 0V, V_{DS} = 0V \text{ to } 48V \bigcirc$
C _{oss eff.} (TR)	Effective Output Capacitance (Time Related)		636			V_{GS} = 0V, V_{DS} = 0V to 48V (6)
Diode Characteristics						
		1			1	

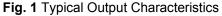
	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current (Body Diode)			99 ①		MOSFET symbol showing the
I _{SM}	Pulsed Source Current (Body Diode) ①			396		integral reverse
V_{SD}	Diode Forward Voltage			1.3	V	T _J = 25°C,I _S = 50A,V _{GS} = 0V ⑤
t _{rr}	Reverse Recovery Time		27 32		ns	$T_{J} = 25^{\circ}C$ $T_{J} = 125^{\circ}C$ $V_{R} = 51V$,
Q _{rr}	Reverse Recovery Charge		31 43		nC	$T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$ $I_F = 50A$ $di/dt = 100A/\mu s$ (5)
			2.1		Α	T _J = 25°C
t _{on}	Forward Turn-On Time	Intrinsic	turn-or	n time is	negligil	ble (turn-on is dominated by $L_{S}+L_{D}$)

Notes:

- ① Calculated continuous current based on maximum allowable junction temperature. Bond wire current limit is 50A. Note that current limitations arising from heating of the device leads may occur with some lead mounting arrangements.
- ② Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- $\$ Limited by T_{Jmax}, starting T_J = 25°C, L = 0.136mH, R_G = 25 Ω , I_{AS} = 50A, V_{GS} =10V. Part not recommended for use above this value.
- $\label{eq:ISD} \textcircled{0.5mu}{0.5mu} I_{SD} \leq 50A, \, di/dt \leq 1109A/\mu s, \, V_{DD} \leq V_{(BR)DSS}, \, T_J \leq 175^{\circ}C.$
- S Pulse width $\leq 400 \mu s$; duty cycle $\leq 2\%$.
- 6 C_{oss eff.} (TR) is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.
- \odot C_{oss eff.} (ER) is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.
- When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994
- $\begin{tabular}{ll} \end{tabular} \end{tabular} & R_{θ} is measured at T_J approximately $90^{\circ}C$. \end{tabular} \end{tabular}$







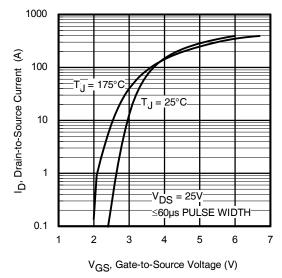


Fig. 3 Typical Transfer Characteristics

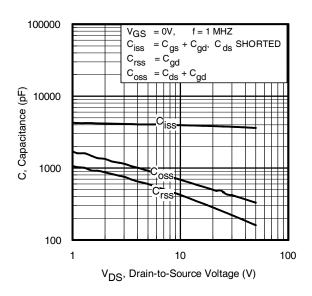


Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

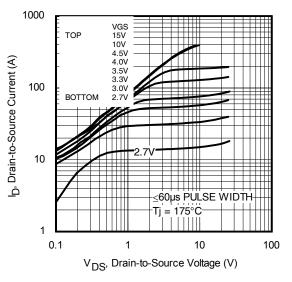


Fig. 2 Typical Output Characteristics

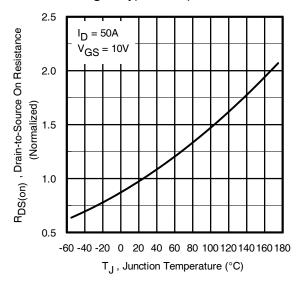


Fig. 4 Normalized On-Resistance vs. Temperature

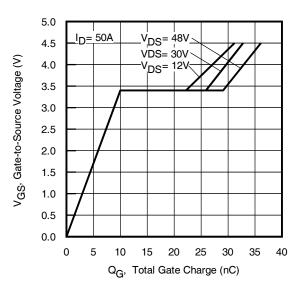
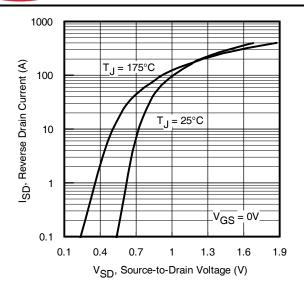
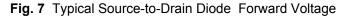
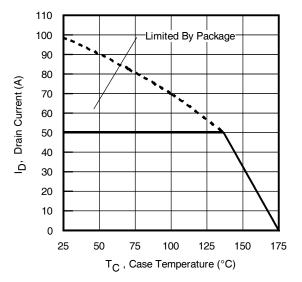


Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

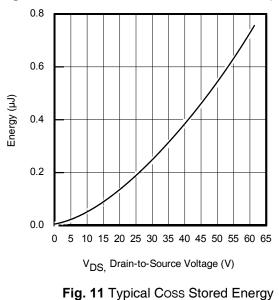












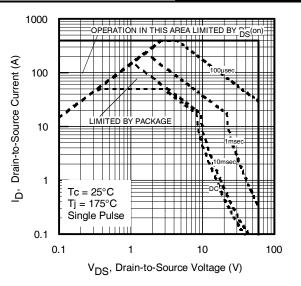


Fig 8. Maximum Safe Operating Area

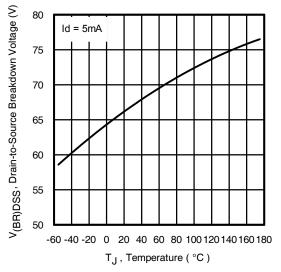


Fig 10. Drain-to-Source Breakdown Voltage

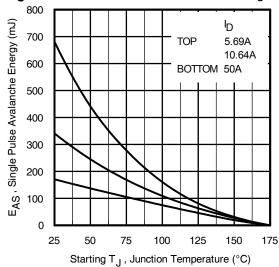


Fig 12. Maximum Avalanche Energy vs. Drain Current



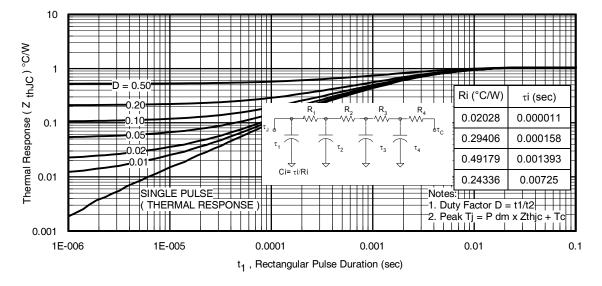


Fig 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case

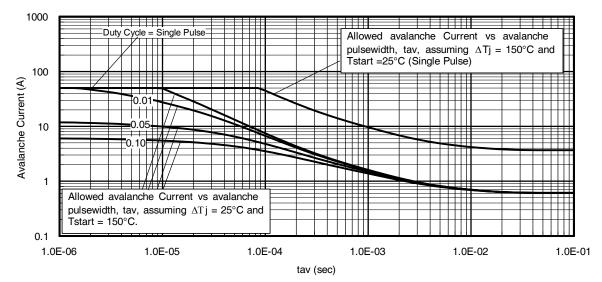


Fig 14. Typical Avalanche Current Vs. Pulse width

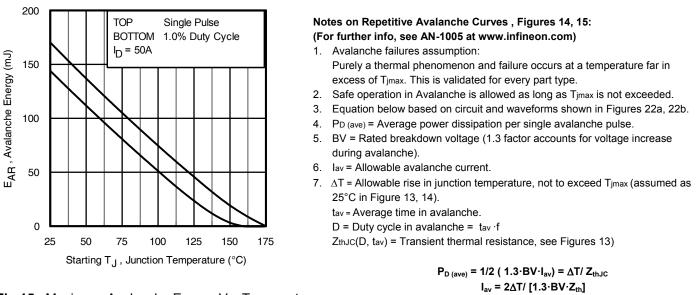
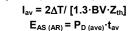
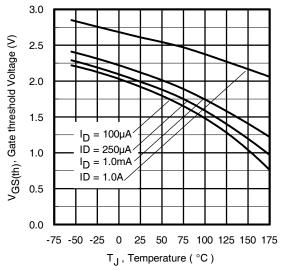


Fig 15. Maximum Avalanche Energy Vs. Temperature









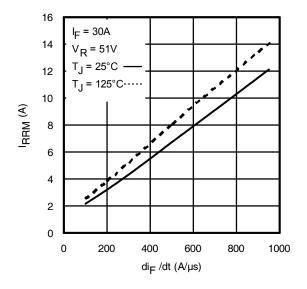


Fig. 18 - Typical Recovery Current vs. dif/dt

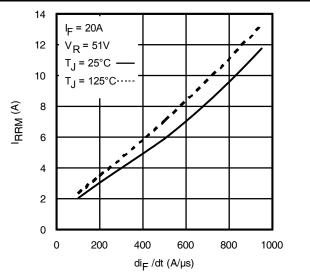


Fig. 17 - Typical Recovery Current vs. dif/dt

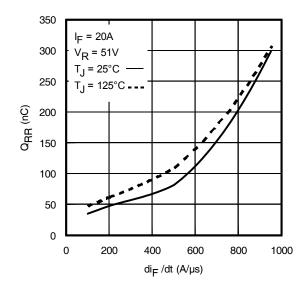


Fig. 19 - Typical Stored Charge vs. dif/dt

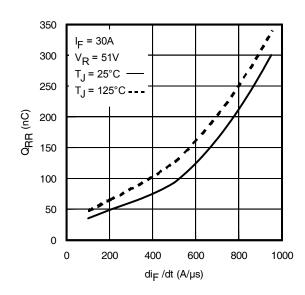
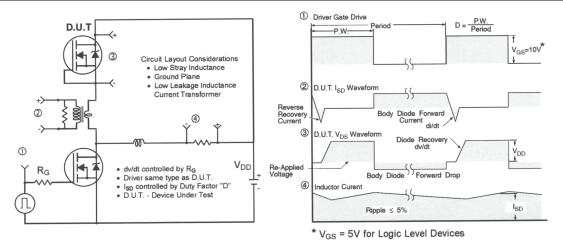
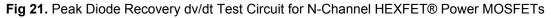


Fig. 20 - Typical Stored Charge vs. dif/dt







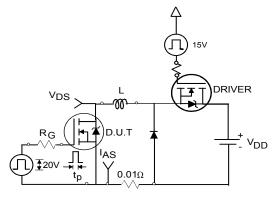


Fig 22a. Unclamped Inductive Test Circuit

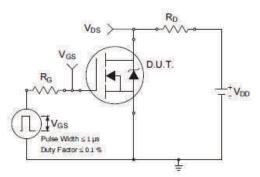
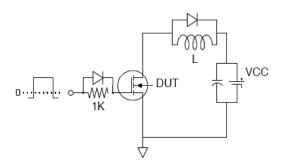
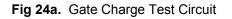


Fig 23a. Switching Time Test Circuit





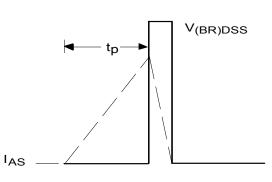


Fig 22b. Unclamped Inductive Waveforms

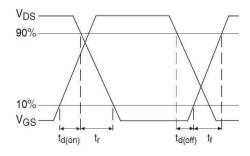


Fig 23b. Switching Time Waveforms

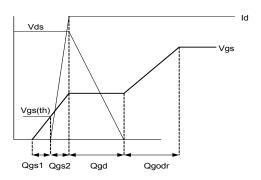
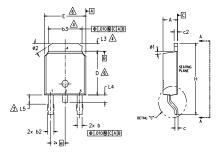


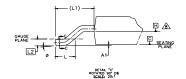
Fig 24b. Gate Charge Waveform

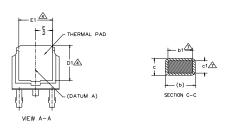


D-Pak (TO-252AA) Package Outline (Dimensions are shown in millimeters (inches))









NOTES:

- 1.- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].
- A- LEAD DIMENSION UNCONTROLLED IN L5.
- A- DIMENSION D1, E1, L3 & 63 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- 5.- SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP.
- ▲ DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- A- DIMENSION 61 & c1 APPLIED TO BASE METAL ONLY.
- $\underline{\&}$ DATUM A & B TO BE DETERMINED AT DATUM PLANE H. 9.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252AA.

S Y M		N O T					
В	MILLIM	ETERS	INC	INCHES			
0 L	MIN.	MAX.	MIN.	MAX.	Ê		
A	2.18	2.39	.086	.094			
A1	-	0.13	-	.005			
b	0.64	0.89	.025	.035			
ь1	0.65	0.79	.025	.031	7		
b2	0.76	1.14	.030	.045			
b3	4.95	5.46	.195	.215	4		
с	0.46	0.61	.018	.024			
c1	0.41	0.56	.016	.022	7		
c2	0.46	0.89	.018	.035			
D	5.97	6.22	.235	.245	6		
D1	5.21	-	.205	-	4		
Е	6.35	6.73	.250	.265	6		
E1	4.32	-	.170	-	4		
е	2.29	BSC	.090	BSC			
Н	9.40	10.41	.370	.410			
L	1.40	1.78	.055	.070			
L1	2.74	BSC	.108	REF.			
L2	0.51	BSC	.020 BSC				
L3	0.89	1.27	.035	.050	4		
L4	-	1.02	-	.040			
L5	1.14	1.52	.045	.060	3		
ø	0.	10*	0.	10*			
ø1	0*	15 °	0.	15°			
ø2	25'	35°	25*	35*			

LEAD ASSIGNMENTS

<u>HEXFET</u>

1.- GATE 2.- DRAIN 3.- SOURCE 4.- DRAIN

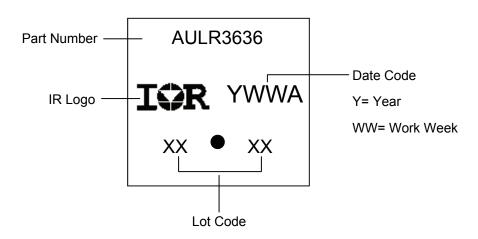
IGBT & CoPAK

1.- GATE

2.- COLLECTOR 3.- EMITTER

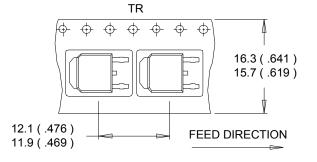
4.- COLLECTOR

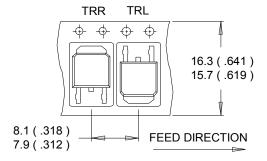
D-Pak (TO-252AA) Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

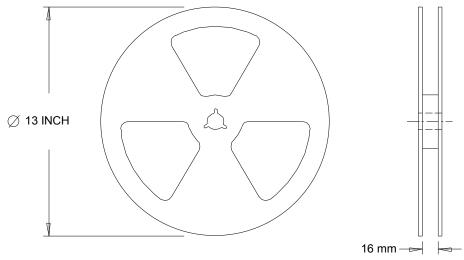
D-Pak (TO-252AA) Tape & Reel Information (Dimensions are shown in millimeters (inches))





NOTES :

- 1. CONTROLLING DIMENSION : MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES : 1. OUTLINE CONFORMS TO EIA-481.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



Qualification Information

		Automotive					
			(per AEC-Q101)				
		Comments: This part number(s) passed Automotive qualification. Infineon's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.					
Moisture Sensitivity Level		D-Pak	MSL1				
	Machine Model	Class M4 (+/- 600V) [†]					
		AEC-Q101-002					
	Liuman Dady Madal	Class H1C (+/- 2000V) [†]					
ESD	Human Body Model	AEC-Q101-001					
	Charged Device Model	Class C5 (+/- 2000V) [†]					
		AEC-Q101-005					
RoHS Compliant			Yes				

† Highest passing voltage.

Revision History

Date	Comments
3/18/2014	 Added "Logic Level Gate Drive" bullet in the features section on page 1 Updated data sheet with new IR corporate template
4/9/2014	 Updated package outline on page 8. Updated typo on the fig.19 and fig.20, unit of y-axis from "A" to "nC" on page 6.
11/4/2015	 Updated datasheet with corporate template Corrected ordering table on page 1.

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